Γ	Twoe	Hits	Search Text	DBs	Time Stamp	Comments	Definition
,	7	195	adhesive with outgassing	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/28 18:44		
, ,		3	((solder adj mask) with out\$lgass\$3)	USPAT; US-PGPUB; EPO; JPO: DERWENT; IBM TDB	2001/11/28 18:51		
۰ ۳	BRS	165	solder same out\$lgass\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/28 19:22		***************************************
4	BRS	10	((solder adj mask) same out\$lgass\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/28 18:52		
2	BRS	73	(solder same out\$lgass\$3) and adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/28 19:21		
9	BRS	24	(solder with out\$1gass\$3) and adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/28 19:22		
7	BRS	850	(solder adj mask) and (adhesive or	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/29 13:19		
	BRS	285	Nicolder adj mask) same (adhesive or bisenaleimide)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/29 13:24		
6	BRS	162	(solder adj mask) same (adhesive or itemaloimide) and (die or Chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/29 13:21		
10		9	ask) same bi	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/29 13:41		
		4	(solder adj mask) and ((bismaleimide or bt)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/29 13:44		
,		1	("6034194"). PN.	USPAT	2001/11/29 13:45		
13		7	isk) and ((bismaleimide or	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/29 13:59		
14	BRS	112	(chip or die) and ((bismaleimide or bt or bm1) with adhesive)	USPAT; US-FGFUB; EFO; JPO; DERWENT; IBM TDB	2001/11/29 13:59		
15	BRS	17	((chip or die) and ((bismaleimide or bt or bmi) with adhesive)) and mask	USPAT; US-PGFUB; EFO; JPO; DERWENT; IBM TDB	2001/11/29 14:07		
16	IS&R	П	("6034194").PN.	USPAT HSDAT: HS-PGPHR: EPO:			
17	BRS	7	((solder adj mask) with outgas\$)	JPO; DERWENT; IBM TDB	2001/11/29 14:18		
18	BRS	15829	cure with adhesive	USPAT; US-PGPUB; EFO; JPO; DERWENT; IBM TDB	2001/11/29 15:54		

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	Type	Hits	Search Text	DBs	Time Stamp	Comments	Definition
				HEDNE HE DEDING FDO:			
٦,	BRS	195	adhesive with outgassing	JPO; DERWENT; IBM TDB	2001/11/28 18:44		
				TICDATE TICEDIDE RPO:			
2	2 BRS	3	((solder adj mask) with out\$1gass\$3)	JPO; DERWENT; IBM TDB	2001/11/28 18:51		
				TO DITO DITO BOO.			
				USPAI; USPAFGEOD; ELO	2001/11/28 19:22		
m	3 BRS	165	solder same outsigasses	JPO; DERWENT; IBM TDB			
				TICDATE TIC-PCPIIR: FPO:			
V	RRS	10	((solder adj mask) same out\$1gass\$3)	TPO: DERWENT: IBM TOB	2001/11/28 18:52		
•)			TODAT. TIS-DEDITE: FDO.			
١,	, G	7.3	lealder same out\$10ass\$3) and adhesive	TOO. DEDUCED IN TOR	2001/11/28 19:21		
n	BK5	2	יייייייייייייייייייייייייייייייייייייי	OFO; DERMENT, IDE IDE			
	+			USPAT; US-PGPUB; EPO;	2001/11/28 19:22		
و	BRS	24	(solder with out\$1gass\$3) and adnesive	JPO; DERWENT; IBM TDB			